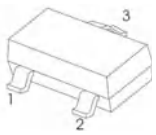
FEATURES

- Complementary to MMBT5551
- Ideal for Medium Power Amplification and Switching

SOT-23



2L

1.BASE
2.EMITTER
3.COLLECTOR

MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

MAXIMUM RATINGS (Ta=25℃ unless otherwise noted)

Parameter	Symbol	Value	Unit
Collector–Base Voltage	V_{CBO}	-160	V
Collector–Emitter Voltage	V_{CEO}	-150	V
Emitter–Base Voltage	V_{EBO}	-5	V
Collector Current — Continuous	I_C	-0.6	A
Collector Dissipation	P_C	0.3	W
Thermal Resistance From Junction To Ambient	R_{thJA}	416	℃/W
Operation Junction and Storage Temperature Range	T_J, T_{stg}	-55~+150	℃

CLASSIFICATION OF $h_{FE(1)}$

RANK	L	H
RANGE	100-200	200-300

ELECTRICAL CHARACTERISTICS (TA = 25°C unless otherwise noted.)

Parameter	Symbol	Test conditions	Min	Typ	Max	Unit
Collector-base breakdown voltage	$V_{(BR)CBO}$	I_C =-100uA, I_E = 0	-160			V
Collector-emitter breakdown voltage	$V_{(BR)CEO}$	I_C =-1 mA, I_B = 0	-150			V
Emitter-base breakdown voltage	$V_{(BR)EBO}$	I_E =-10uA, I_C = 0	-5			V
Collector cut-off current	I_{CBO}	V_{CB} =-120V, I_E = 0			-0.1	uA
Emitter cut-off current	I_{EBO}	V_{EB} =-4V, I_C = 0			-0.1	uA
DC current gain	h_{FE1}	V_{CE} =-5V, I_C =-1mA	80			
	h_{FE2}	V_{CE} =-5V, I_C =-10mA	100		300	
	h_{FE3}	V_{CE} =-5V, I_C =-50mA	50			
Collector-emitter saturation voltage	$V_{CE(sat)1}$	I_C =-10mA, I_B =-1mA			-0.2	V
	$V_{CE(sat)2}$	I_C =-50mA, I_B =-5mA			-0.5	V
Base-emitter saturation voltage	$V_{BE(sat)1}$	I_C =-10mA, I_B =-1mA			-1	V
	$V_{BE(sat)2}$	I_C =-50mA, I_B =-5mA			-1	V
Transition frequency	f_T	V_{CE}=-25V,I_C=-10mA, f=30MHz	100			MHZ

RATING AND CHARACTERISTIC CURVES

Fig.1 Static characteristics

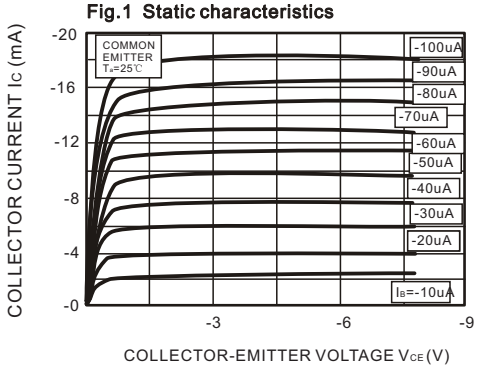


Fig.2 P_C —— T_a

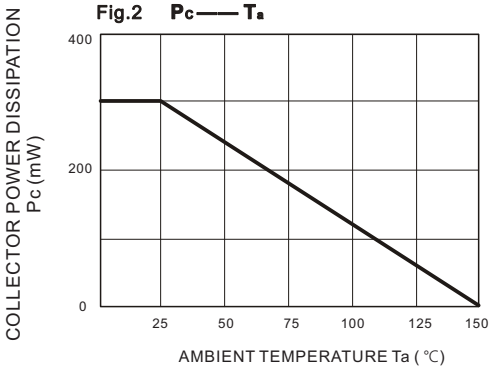


Fig.3 C_{ob} / C_{ib} —— V_{CB} / V_{EB}

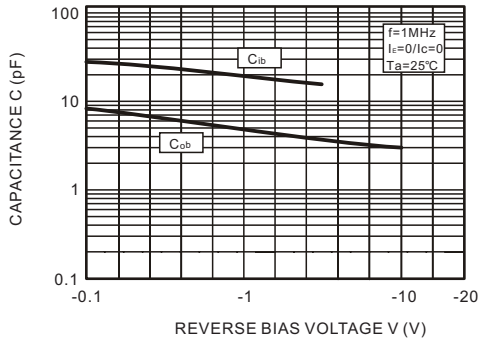


Fig.4 V_{CEsat} —— I_C

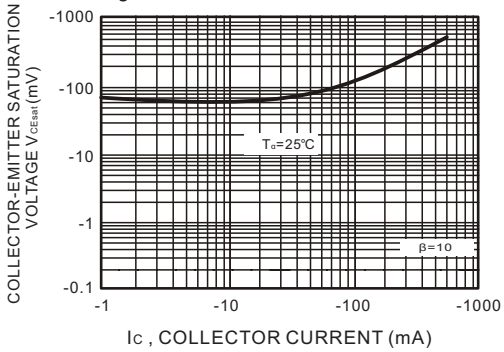


Fig.5 h_{FE}--Ic

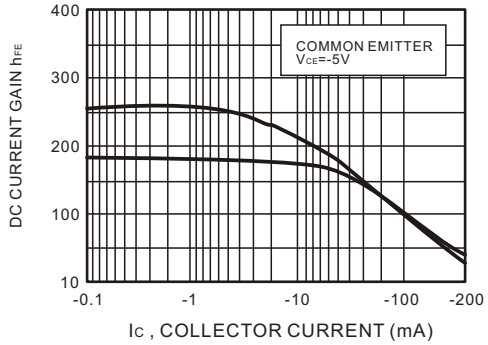


Fig.6 V_{BEsat} —— I_C

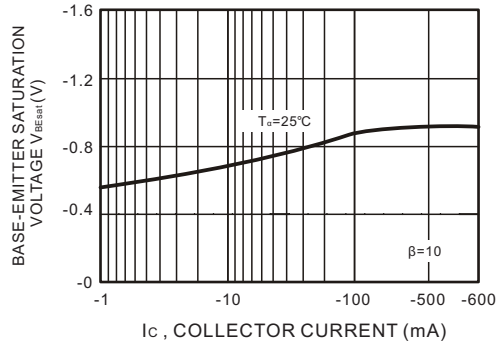


Fig.7 I_C —— V_{BE}

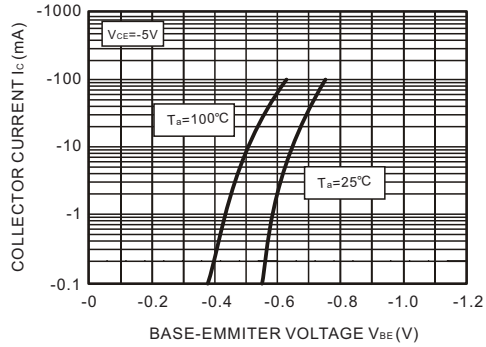
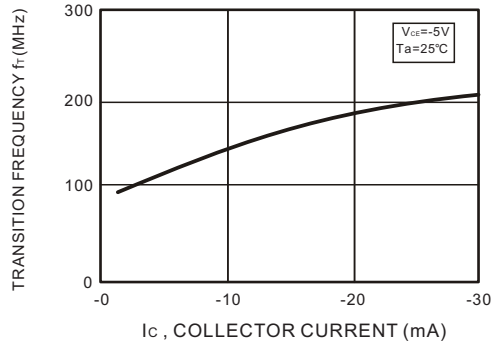


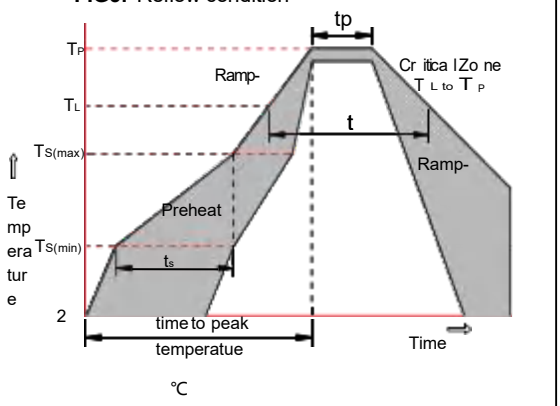
Fig.8 f_T —— I_C



Soldering parameters

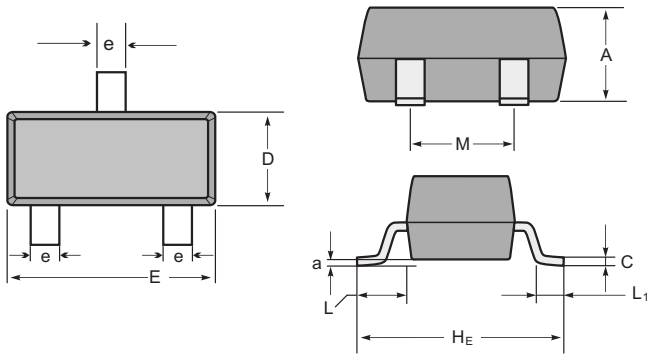
Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃ of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃

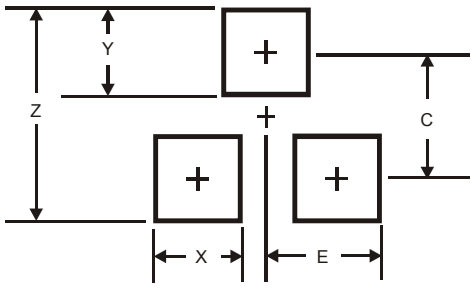
FIG5: Reflow condition



Package Dimensions & Suggested Pad Layout

SOT23





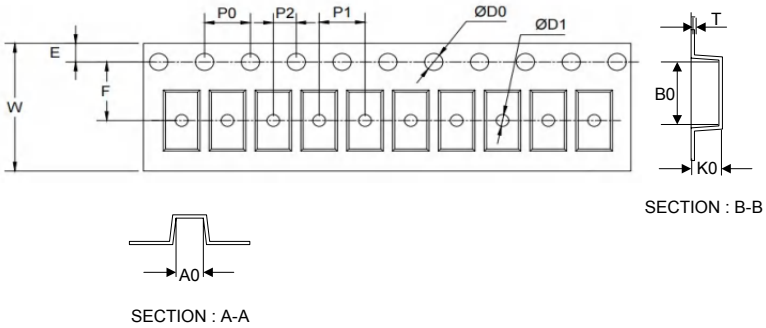
SOT-23 mechanical data

UNIT		A	C	D	E	H_E	e	M	L	L_1	a
mm	max	1.1	0.15	1.4	3.0	2.6	0.5	1.95	0.55 (ref)	0.36 (ref)	0.0
	min	0.9	0.08	1.2	2.8	2.2	0.3	1.7			0.15
mil	max	43	6	55	118	102	20	77	22 (ref)	14 (ref)	0.0
	min	35	3	47	110	87	12	67			6

Dimensions	SOT23
Z	2.9
X	0.8
Y	0.9
C	2.0
E	1.35

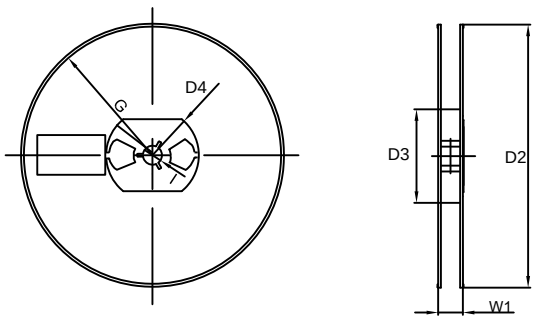
Tape & rell specification

Tape



Symbol	Dimension (mm)
P0	4.00±0.10
P1	4.00±0.10
P2	2.00±0.10
D0	1.55±0.10
D1	1.05±0.10
E	1.55±0.10
F	3.60±0.10
W	8.00±0.10
A0	3.80±0.20
B0	3.25±0.20
K0	1.45±0.10
T	0.25±0.05

7” Reel



D2	178.0±3.0
D3	55Min.
D4	R24.0±3.0
G	R82.0±3.0
I	13.0±2.0
W1	11.0±3.0

Quantity: 3000PCS